

# MICROCIRCUIT DATA SHEET

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MNDS90LV032A-X REV 0A0

# Low Voltage LVDS Quad CMOS Differential Line Receiver

### General Description

The DS90LV032A is a quad differential line receiver designed for applications requiring low power dissipation and high data rates.

The DS90LV032A accepts low voltage differential input signals and translates them to 3V CMOS output levels. The receiver supports a TRI-STATE function that may be used to multiplex outputs.

The DS90LV032A and companion LVDS line driver (DS90LV031A) provide a new alternative to high power pseudo-ECL devices for high speed point to point interface applications.

## Industry Part Number

NS Part Numbers

DS90LV032A

DS90LV032AW-QML\* DS90LV032AWGMLS DS90LV032AWGQML\*\*

#### Prime Die

DS90LV032A

#### Controlling Document

5962-9865201QFA\*, QXA\*\*

Processing	Subgrp	Description	Temp (°C)
MIL-STD-883, Method 5004	1	Static tests at	+25
	2	Static tests at	+85
	3	Static tests at	-55
Quality Conformance Inspection	4	Dynamic tests at	+25
	5	Dynamic tests at	+85
MIL-STD-883, Method 5005	6 7	Dynamic tests at Functional tests at	-55 +25
	8A	Functional tests at	+85
	8B	Functional tests at	-55
	9	Switching tests at	+25
	10	Switching tests at	+85
	11	Switching tests at	-55

### **Features**

- Accepts small swing (330 mV) differential signal levels.
- Low power dissipation.
- Low differential skew.
- Low chip to chip skew
- +85C thru -55C operating temperature range
- Pin compatible with DS90C032A and DS26C32A.
- Compatible with ANSI/TIA/EIA-644
- Typical Rise/Fall time is TBD

# (Absolute Maximum Ratings)

(Note 1)

Supply Voltage (Vcc) -0.3 to +4VInput Voltage (RIN+, RIN-) -0.3 to 3.9V Enable Input Voltage (EN, EN\*) -0.3 to (Vcc+0.3V) Output Voltage (ROUT) -0.3 to (Vcc+0.3V) Storage Temperature Range (Tstg) -65C to + 150C Lead Temperature Soldering 4 seconds 260 C Maximum Package Power Dissipation @ +25C (Note 2) 16 PIN CERPAK (W Pkg) 845mW 16 PIN CERAMIC SOIC (WG Pkg) 845mW Thermal Resistance. (Theta JA) 16 PIN CERPAK (W Pkg) 148 C/W 16 PIN CERAMIC SOIC (WG Pkg) 148 C/W Thermal Resistance. (Theta JC) 16 PIN CERPAK (W Pkg) 21 C/W 16 PIN CERAMIC SOIC (WG Pkg) 21 C/W ESD Rating. 4500 Volts. Maximum Junction Temperature +150C

Note 1: Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Derate (W & WG Pkgs) @ 6.8 mW/C above +25C.

# Recommended Operating Conditions

Operating Voltage (Vcc)

3.15V to 3.45V

Operating Temperature Range (Ta)

-55C to +85C

Receiver Input Voltage

GND to 3.0V

# Electrical Characteristics

# DC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)

DC: Over supply voltage range of 3.15V to 3.45V and operating temperature of -55C to +85C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
VTL	Differential Input Low Threshold	Vcm = +1.2V	1	RIN+, RIN-	-100		mV	1, 2,
VTH	Differential Input High Threshold	Vcm = +1.2V	1	RIN+, RIN-		100	mV	1, 2,
VCMR	Common Mode Voltage Range	VID = 200mV peak to peak	1, 4	RIN+, RIN-	0.1	2.3	V	1, 2,
IIN Input Current	Vcc = 3.45V or 0V, Vin = 2.8V or 0V		RIN+, RIN-		<u>+</u> 10	uA	1, 2,	
	Vcc = 0V, Vin = 3.45V		RIN+, RIN-		<u>+</u> 20	uA	1, 2,	
VOH Output High Voltage	Ioh = -0.4 mA, Vid = 200mV		ROUT	2.7		V	1, 2,	
	Ioh = -0.4 mA, Inputs Open		ROUT	2.7		V	1, 2,	
VOL	Output Low Voltage	Iol = 2 mA, Vid = -200mV		ROUT		0.25	V	1, 2,
IOS	Output Short Circuit Current	Enabled, Vout = 0V	5	ROUT	-15	-120	mA	1, 2,
IOZ	Output TRI-STATE Current	Disabled, Vout = 0V or Vcc		ROUT		<u>+</u> 10	uA	1, 2,
VIH	Input High Voltage		6	EN, EN*	2.0	Vcc	V	1, 2,
VIL	Input Low Voltage		6	EN, EN*	GND	0.8	V	1, 2,
II	Input Current	Vin = Vcc or 0V, Other Input = Vcc or GND		EN, EN*		<u>+</u> 10	uA	1, 2,
VCL	Input Clamp Voltage	Icl = -18mA		EN, EN*		-1.5	V	1, 2,
Icc No Load Supply Current Receivers Enabled	EN, EN* = Vcc or GND, Inputs Open		Vcc		15	mA	1, 2,	
	FIIADIEU	EN, EN* = 2.4 or 0.5, Inputs Open		Vcc		15	mA	1, 2,
IccZ	No Load Supply Current Receivers Disabled	EN = GND, EN* = Vcc , Inputs Open		Vcc		5	mA	1, 2,

## Electrical Characteristics

#### AC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.) AC: VCC = 3.15/3.30/3.45V, CL = 20pF

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
tPHLD	Differential Propagation Delay High to Low	Vid = 200mV, Input pulse = 1.1V to 1.3V, Vin = 1.2V (0 differential) to Vout = 1/2 Vcc			0.5	3.5	ns	9, 10, 11
tPLHD	Differential Propagation Delay Low to High	Vid = 200mV, Input pulse = 1.1V to 1.3V, Vin = 1.2V (0V differential) to Vout = 1/2 Vcc			0.5	3.5	ns	9, 10, 11
tSKD	Differential Skew   tPHLD-tPLHD	CL = 20pF, Vid = 200mV				1.5	ns	9, 10, 11
tSK1	Channel to Channel Skew	CL = 20pF, Vid = 200mV	2			1.75	ns	9, 10, 11
tSK2	Chip to Chip Skew	CL = 20pF, Vid = 200mV	3			3.0	ns	9, 10, 11
tPLZ	Disable Time Low to Z	Input pulse = 0V to 3.0V, Vin = 1.5V, Vout = Vol+0.5V, RL= 1K Ohm.				12	ns	9, 10, 11
tPHZ	Disable Time High to Z	Input pulse = 0V to 3.0V, Vin = 1.5V, Vout = Voh-0.5V, RL = 1K Ohm.				12	ns	9, 10, 11
tPZH	Enable Time Z to High	Input pulse = 0V to 3.0V, Vin = 1.5V, Vout = 50%, RL = 1K Ohm.				20	ns	9, 10, 11
tPZL	Enable Time Z to Low	Input pulse = 0V to 3.0V, Vin = 1.5V, Vout = 50%, RL = 1K Ohm.				20	ns	9, 10, 11

- Note 1: Tested during VOH/VOL tests by applying appropriate voltage levels to the input pins of the device under test.
- Note 2: Channel to Channel Skew is defined as the difference between the propagation delay of one channel and that of the others on the same chip with any event on the inputs.
- Note 3: Chip to Chip Skew is defined as the difference between the minimum and maximum specified differential propagation delays.
- Note 4: The VCMR range is reduced for larger input differential voltage (VID). Example: If VID = 400mV, the VCMR is 0.2V to 2.2V. A VID up to Vcc- 0V may be applied to the Rin+/Rin- inputs with the Common-Mode voltage set to Vcc/2.
- Note 5: Output short circuit current (Ios) is specified as magnitude only, minus sign indicates direction of current. Only one output should be shorted at a time, do not exceed maximum junction temperature.
- Note 6: Tested during IOZ tests by applying appropriate threshold voltage levels to the EN and EN\* pins.

# Graphics and Diagrams

GRAPHICS#	DESCRIPTION
W16ARL	CERPACK (W), 16 LEAD (P/P DWG)
WG16ARC	CERAMIC SOIC (WG), 16 LEAD (P/P DWG)

See attached graphics following this page.



